503381818 07/07/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3428440

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the THE DOCKET NUMBER SHOULD BE CORRECTED TO 18506-611 previously recorded on Reel 035982 Frame 0873. Assignor(s) hereby confirms the THE ASSIGNMENT OF THE ENTIRE INTEREST.

CONVEYING PARTY DATA

Name	Execution Date
CHIN-I LIAO	06/18/2015
SHIH-CHIEH CHANG	06/18/2015
HSIU-TING CHEN	06/19/2015
SHIH-HSIEN CHENG	06/18/2015

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14674474

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9493872885

Email: inbox@wpatca.com
Correspondent Name: ANTHONY KING

Address Line 1: 1100 QUAIL STREET, SUITE 204

Address Line 4: NEWPORT BEACH, CALIFORNIA 92660

ATTORNEY DOCKET NUMBER: 18506-811

NAME OF SUBMITTER: ANTHONY KING

SIGNATURE: /Anthony King/

DATE SIGNED: 07/07/2015

Total Attachments: 5

source=CoverSheet#page1.tif

PATENT REEL: 036074 FRAME: 0414

503381818

source=Notice#page1.tif source=Notice#page2.tif source=US5308-Assignment#page1.tif source=US5308-Assignment#page2.tif

> PATENT REEL: 036074 FRAME: 0415

503379531 07/06/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3426153

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHIN-I LIAO	06/18/2015
SHIH-CHIEH CHANG	06/18/2015
HSIU-TING CHEN	06/19/2015
SHIH-HSIEN CHENG	06/18/2015

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14674474

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 949 387 2885
Email: inbox@wpatca.com

Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS

Address Line 1: 1100 QUAIL STREET, SUITE 202

Address Line 4: NEWPORT BEACH, CALIFORNIA 92660

ATTORNEY DOCKET NUMBER:	8560-811	
NAME OF SUBMITTER:	ANTHONY KING	
SIGNATURE:	/Anthony King/	
DATE SIGNED:	07/06/2015	

Total Attachments: 2

source=US5308-Assignment#page1.tif source=US5308-Assignment#page2.tif

PATENT REEL: 036074 FRAME: 0416

ciliaob 2015/06/11 19:42:22

ASSIGNMENT

WHEREAS, I(we), <u>LIAO</u>, <u>CHIN-I</u>, <u>CHANG</u>, <u>SHIH-CHIEH</u>, <u>CHEN</u>, <u>HSIU-TING</u>, and <u>CHENG</u>, <u>SHIH-HSIEN</u>, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

SEMICONDUCTOR STRUCTURE HAVING ENLARGED REGROWTH REGIONS AND MANUFACTURING METHOD OF THE SAME

AND MANOFACT URING	METHOD OF THE SAME
(hereinafter referred to as the INVENTION) for which an applie executed on even date herewith unless at least one of the ☐ United States Design Patent was	plication for United States Letters Patent /Utility Patent e following is checked:
□ executed on:	· ,
	al No.: 14/674,474
☐ established by PCT International Patent Application	
United States of America	in 140
☐ issued on as U.S. Patent No.	
	•
WHEREAS, TAIWAN SEMICONDUCTOR MANU	JFACTURING COMPANY LTD. whose post office
address is NO.8, LI-HSIN RD. 6, HSINCHU SC	CIENCE PARK. HSINCHU, TAIWAN, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiri	ng the entire right, title and interest in and to the same in
the United States and its territorial possessions;	
NOW, THEREFORE, for good and valuable consider	ration, receipt of which is hereby acknowledged, I (we),
ASSIGNOR, by these presents do sell, assign and transfer to	unto said ASSIGNEE, the entire right, title, and interest in
and to said INVENTION and application throughout the I	United States of America, including any and all Letters
Patent granted on any division, continuation, continuation,	in-part and reissue of said application for the full term or
terms for which the same may be granted, including all pri	ority rights under any International Convention.
ACCIGNOD further assessments that no accions and	
or entered into which would conflict with this Assignment	ale, agreement or encumbrance has been or will be made
of entered into which would control with this Assignment	;
ALSO, ASSIGNOR hereby agrees to execute any docur	nents that legally may be required in connection with the
filing, prosecution and maintenance of said application of	rems that regard may be required in connection with the
said Invention, including additional documents that ma	t any other patent application(s) in the office brates to be required to affirm the rights of Agglobies in and to
said Invention, all without further consideration. Ass	IGNOR also agrees without further consideration and at
ASSIGNEE'S expense, to identify and communicate to Ass	IGNEE at ASSIGNEE'S request documents and information
concerning the INVENTION that are within Assignor's pos	ssession or control, and to provide further assurances and
testimony on behalf of ASSIGNEE that lawfully may be	e required of ASSIGNOR in respect of the prosecution
maintenance, litigation and defense of any patent appli	cation or patent encompassed within the terms of this
instrument. ASSIGNOR'S obligations under this instr	ument shall extend to ASSIGNOR'S heirs, executors;
administrators and other legal representatives.	31:

ALSO, ASSIGNOR hereby authorizes and requests the	e Commissioner of Patents and Trademarks to issue any
and all Letters Patent referred to above to Assignee, as the	e ASSIGNEE of the entire right, title and interest in and to
the same, for ASSIGNEE'S sole use and behoof; and for the	use and behoof of ASSIGNEE'S legal representatives and
successors, to the full end of the term for which such Le	tters Patent may be granted, as fully and entirely as the
same would have been held by ASSIGNOR had this assignment	nent and sale not been made.
Assignor Name	Address
LIÃO, CHIN-I	9F., NO.86, DONGXING RD., EAST DIST.,
N / lea	TAINAN CITY 701, TAIWAN (R.O.C.)
(Nin ') liad	
Signature of Assignor	Date of Signature 1 Sc / A
(X) him (/ far)	(X) >0 (5 / 6 / 18
Name of Witness (optional)	Name of Witness (optional)
	rance of reaces (optional)
Signature of Witness (optional)	Signature of Witness (Optional)
(

PATENT

REEL: 036074 FRAME: 0417

Assignor Name -CHANG, SHIH-CHIEH	Address NO.476, SHEZHONG ST., SHILIN DIST., TAIPEI CITY 111, TAIWAN (R.O.C.)
(X) Clay Shh-Chel	Date of Signature (X) >015/6/18
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name - CHEN, HSIU-TING	NO.15, LN.168, SEC.1, FUCIANG RD.,
二个子	YONGKANG DIST., TAINAN CITY 71062, TAIWAN (R.O.C.)
Signature of Assignor Hury Frg: Chen	Date of Signature (X) \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHENG, SHIH-HSIEN	Address NO.409, FUGUO 1ST RD., YONGKANG DIST., TAINAN CITY 710, TAIWAN (R.O.C.)
Signature of Assignor (X) CHBNG, SHIH—HSLEN.	Date of Signature (X) >015 / 6/18
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

-2-